

7.0V to 9.5V

0.001% (Typ)

0.002% (Typ)

2.3Vrms(Typ)

-100dB(Typ)

-40°C to +85°C

38mA (Typ)

Sound Processor with Built-in 3-band Equalizer **BD37544FS**

General Description

BD37544FS is a sound processor with built-in 3-band equalizer for car audio. The functions are stereo input selector (which can switch single and GND isolation), input-gain control, main volume, super bass, 5ch fader volume, LPF/HPF for subwoofer, and mixing input. Moreover, "Advanced switch circuit", which is an original ROHM technology, can reduce various switching noise (ex. No-signal, low frequency like 20Hz & large signal inputs). Also, "Advanced switch" makes control of microcomputer easier, and can construct a high quality car audio system.

Features

- Reduced switching noise of input gain control, mute, main volume, fader volume, bass, middle, treble, super bass, mixing by using advanced switch circuit.
- Built-in differential input selector that can make various combination of single-ended / differential input.
- Built-in ground isolation amplifier inputs, which is ideal for external stereo input.
- Built-in input gain controller reduces switching noise for volume of a portable audio input.
- Decreased number of external components due to built-in 3-band equalizer filter, LPF for subwoofer, and HPF. It is possible to control Q, Gv, fo of 3-band equalizer and fc of LPF/HPF through I²C BUS control.
- It is possible to adjust the gain of the bass, middle, and treble up to ±20dB with 1 dB step gain adjustment.
- It is equipped with output terminals for Subwoofer. Moreover, the stereo signal output of the front and rear can also be chosen by the I²C BUS control.
- Built-in mixing input and mixing attenuator.
- Energy-saving design resulting in low-current consumption is achieved by utilizing the Bi-CMOS process. It has the advantage in quality over scaling down the power heat control of the internal regulators.
- Input terminals and output terminals are organized and separately laid out to keep the signal flow in one direction which results in simpler and smaller PCB lavout.
- It is possible to control the I²C BUS by 3.3V / 5V.

Applications

It is optimal for car audio systems. It can also be used for audio equipment of mini Compo, micro Compo, TV, etc.

Key Specifications

- Power Supply Voltage Range:
- Circuit Current (No Signal):
- Total Harmonic Distortion: THD+N1 THD+N2 Maximum Input Voltage:
- Cross-talk Between Selectors:
- Volume Control Range:
- +15 dB to -79dB Output Noise Voltage: V_{NO1} 3.8µVrms(Typ) V_{NO2} 4.8µVrms(Typ) 1.8µVrms(Typ)
- Residual Output Noise Voltage:
- **Operating Temperature Range:**

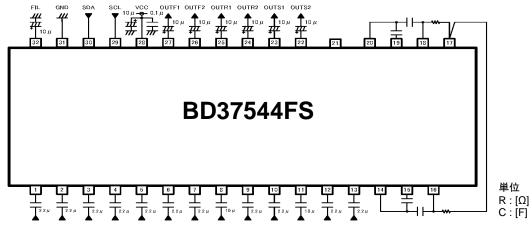
Package

W(Typ) x D(Typ) x H(Max)

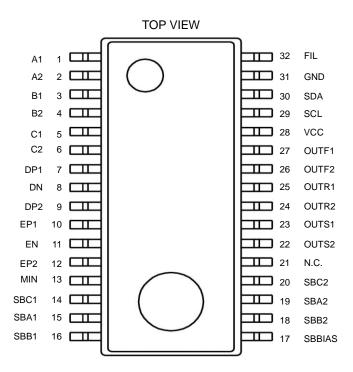


OProduct structure : Silicon monolithic integrated circuit OThis product has no designed protection against radioactive rays

Typical Application Circuit



Pin Configuration



Pin Descriptions

| Pin No. | Pin Name | Description | Pin No. | Pin Name | Description |
|---------|----------|-----------------------------------|---------|-------------|---|
| 1 | A1 | A input terminal of 1ch | 17 | SBBIAS | SuperBass bias terminal |
| 2 | A2 | A input terminal of 2ch | 18 | SBB2 | SuperBass setting terminal of 2ch |
| 3 | B1 | B input terminal of 1ch | 19 | SBA2 | SuperBass setting terminal of 2ch |
| 4 | B2 | B input terminal of 2ch | 20 | SBC2 | SuperBass setting terminal of 2ch |
| 5 | C1 | C input terminal of 1ch | 21 | N.C. | No connection |
| 6 | C2 | C input terminal of 2ch | 22 | OUTS2 | Subwoofer output terminal of 2ch |
| 7 | DP1 | D positive input terminal of 1ch | 23 | OUTS1 | Subwoofer output terminal of 1ch |
| 8 | DN | D negative input terminal | 24 | OUTR2 | Rear output terminal of 2ch |
| 9 | DP2 | D positive input terminal of 2ch | 25 | OUTR1 | Rear output terminal of 1ch |
| 10 | EP1 | E positive input terminal of 1ch | 26 | OUTF2 | Front output terminal of 2ch |
| 11 | EN | E negative input terminal | 27 | OUTF1 | Front output terminal of 1ch |
| 12 | EP2 | E positive input terminal of 2ch | 28 | VCC | Power supply terminal |
| 13 | MIN | Mixing input terminal | 29 | SCL | I ² C Communication clock terminal |
| 14 | SBC1 | SuperBass setting terminal of 1ch | 30 | SDA | I ² C Communication data terminal |
| 15 | SBA1 | SuperBass setting terminal of 1ch | 31 | GND | GND terminal |
| 16 | SBB1 | SuperBass setting terminal of 1ch | 32 | FIL | VCC/2 terminal |

Block Diagram

| 32 31 30 29 28 | 27 26 | 25 24 | 23 22 | 21 | 20 | 19 18 | 17 |
|---|-----------------|--------------------------------|-----------------------|----------------------|----|-------|----------|
| V 777 VCC/2 GND I2C BUS LOGIC | | | | | | | VCC/2 |
| ■ Fader Gain:+15dB to -79dB/1dB step | | | | የ | | | |
| ★no pop noise ■LPF fc=55/85/120/160Hz | | | | | | | |
| HPF fc=55/85/120/160Hz ■ATT Gain: +7dB to -79dB/1dB step | Fader | Fader★ | Fader | ATT★ | | | |
| ★no pop noise Super Bass ★no pop noise 3 Band P-EQ (Tone control) Gain: +20dB to -20dB/1dB step | | | | | | | |
| ★no pop noise •Bass: f0=60/80/100/120Hz Q=0.5/1.0/1.5/2.0 •Meddle:f0=500/1k/1.5k/2.5kHz | | | | | | | |
| Q=0.75/1/.25/1.5 •Treble : f0=7.5k/10k/12.5k/15kHz Q=0.75/1.25 | | ★Super Bass | | | | | |
| ■Volume Gain: +15dB to -79dB/1dB step | | ★3 Band P-EG (Tone control) | Į | | | | |
| ★no pop noise ■Input Gain Gain: +20dB to -0dB/1dB step | | ★Volume/Mute | | | | | |
| ★no pop noise | | ★Input Gain | | | | | |
| Input selector | (3 single-end a | nd 2 stereo ISO) |) | | | | |
| | Buffe ISO | rdGND amp ISO amp | BufferdGND ISO amp | ufferdGND ISO amp | | | |
| | | | | | | | <u> </u> |
| 1 2 3 4 5 | 6 7 | 89 | 10 11 | 12 13 | 14 | 15 | 16 |

Absolute Maximum Ratings (Ta=25°C)

| Parameter Symbol | | Rating | Unit |
|----------------------|-----------------|---------------------------------|------|
| Power Supply Voltage | Vcc | 10.0 | V |
| Input Voltage | V _{IN} | V _{cc} +0.3 to GND-0.3 | V |
| Power Dissipation | Pd | 0.95 (Note 1) | W |
| Storage Temperature | Tstg | -55 to +150 | °C |

(Note 1) When mounted on the standard board (70 x 70 x 1.6 mm³), derate by 7.6mW/°C for Ta above 25°C.

 Caution: Operating the IC over the absolute maximum ratings may damage the IC. The damage can either be a short circuit between pins or an open circuit between pins and the internal circuitry. Therefore, it is important to consider circuit protection measures, such as adding a fuse, in case the IC is operated over the absolute maximum ratings.

Recommended Operating Conditions

| Parameter | Symbol | Min | Тур | Max | Unit |
|----------------------|--------|-----|-----|-----|------|
| Power Supply Voltage | Vcc | 7.0 | - | 9.5 | V |
| Temperature | Topr | -40 | - | +85 | °C |

Electrical Characteristics

(Unless specified, Ta=25°C, V_{CC}=8.5V, f=1kHz, V_{IN}=1Vrms, Rg=600Ω, R_L=10kΩ, A1 input, Input gain 0dB, Mute OFF, Volume 0dB, Tone control 0dB, Loudness 0dB, LPF OFF, HPF OFF, Mixing OFF, Fader 0dB)

| BLOCK | Parameter | Symbol | • | Limit | G | Unit | Conditions | |
|----------|---|-------------------|------|-------|------|-------|--|--|
| BLC | Parameter | Symbol | Min | Тур | Max | Unit | Conduons | |
| | Circuit Current (No Signal) | la | - | 38 | 48 | mA | No signal | |
| | Voltage Gain | Gv | -1.5 | 0 | +1.5 | dB | G _V =20log(V _{OUT} /V _{IN}) | |
| | Channel Balance | СВ | -1.5 | 0 | +1.5 | dB | $CB = G_{V1}-G_{V2}$ | |
| | Total Harmonic Distortion 1 (FRONT,REAR) | THD+N1 | - | 0.001 | 0.05 | % | V _{OUT} =1Vrms BW=400Hz-30KHz | |
| | Total Harmonic Distortion 2 (SUBWOOFER) | THD+N2 | - | 0.002 | 0.05 | % | V _{OUT} =1Vrms BW=400Hz-30KHz | |
| GENERAL | Output Noise Voltage 1 (FRONT,REAR) * | V _{NO1} | - | 3.8 | 15 | μVrms | Rg = 0Ω BW = IHF-A | |
| GENI | Output Noise Voltage 2 (SUBWOOFER) * | V_{NO2} | - | 4.8 | 15 | µVrms | Rg = 0Ω BW = IHF-A | |
| | Residual Output Noise Voltage* | V _{NOR} | - | 1.8 | 10 | μVrms | Fader = -∞dB Rg = 0Ω BW = IHF-A | |
| | Cross-talk Between Channels * | СТС | - | -100 | -90 | dB | $\begin{array}{l} Rg = 0\Omega \\ CTC = 20log(V_{OUT}/V_{IN}) \\ BW = IHF-A \end{array}$ | |
| | Ripple Rejection | RR | - | -70 | -40 | dB | f=1kHz V _{RR} =100mVrms RR=20log(V _{CC} IN/V _{OUT}) | |
| | Input Impedance(A, B,C) | R _{IN_s} | 70 | 100 | 130 | kΩ | | |
| ~ | Input Impedance(D, E) | RIN_D | 175 | 250 | 325 | kΩ | | |
| SELECTOR | Maximum Input Voltage | V _{IM} | 2.1 | 2.3 | - | Vrms | V _{IM} at THD+N(V _{OUT})=1% BW=400Hz-30KHz | |
| UT SEL | Cross-talk Between Selectors * | СТЅ | - | -100 | -90 | dB | $\label{eq:response} \begin{array}{l} Rg = 0\Omega \\ CTS = 20 log(V_OUT/V_IN) \\ BW = IHF-A \end{array}$ | |
| INPUT | Common Mode Rejection Ratio* | CMRR | 50 | 65 | - | dB | XP1 and XN input XP2 and XN input CMRR=20log(V _{IN} /V _{OUT}) BW = IHF-A,[*XD,E] | |

Electrical Characteristics - continued

| | | | | Limit | | | | | |
|---------|-------------------------|--------------------|-----|-------|-----|------|---|--|--|
| BLOCK | Parameter | Symbol | Min | Тур | Max | Unit | Conditions | | |
| GAIN | Minimum Input Gain | Gin_min | -2 | 0 | +2 | dB | Input gain 0dB V _{IN} =100mVrms G _{IN} =20log(V _{OUT} /V _{IN}) | | |
| INPUT G | Maximum Input Gain | Gin_max | 18 | 20 | 22 | dB | Input gain 20dB V _{IN} =100mVrms G _{IN} =20log(V _{OUT} /V _{IN}) | | |
| | Gain Set Error | Gin_err | -2 | 0 | +2 | dB | GAIN=+20dB to +1dB | | |
| MUTE | Mute Attenuation * | Gmute | - | -105 | -85 | dB | Mute ON G _{MUTE} =20log(V _{OUT} /V _{IN}) BW = IHF-A | | |
| | Maximum Gain | G _{V_MAX} | 13 | 15 | 17 | dB | Volume = $15dB$ V _{IN} =100mVrms G _V =20log(V _{OUT} /V _{IN}) | | |
| VOLUME | Maximum Attenuation * | Gv_min | - | -100 | -85 | dB | $ Volume = -∞dB \\ G_V=20log(V V_{OUT}/V_{IN}) \\ BW = IHF-A $ | | |
| 02 | Attenuation Set Error 1 | Gv_err1 | -2 | 0 | +2 | dB | GAIN & ATT=+15dB to -15dB | | |
| | Attenuation Set Error 2 | G_{V_ERR2} | -3 | 0 | +3 | dB | ATT=-16dB to -47dB | | |
| | Attenuation Set Error 3 | Gv_err3 | -4 | 0 | +4 | dB | ATT=-48dB to -79dB | | |
| | Maximum Boost Gain | GB_BST | 18 | 20 | 22 | dB | Gain=+20dB f=100Hz V _{IN} =100mVrms G _B =20log (V _{OUT} /V _{IN}) Gain=-20dB f=100Hz V _{IN} =2Vrms G _B =20log (V _{OUT} /V _{IN}) | | |
| BASS | Maximum Cut Gain | Gb_cut | -22 | -20 | -18 | dB | | | |
| | Gain Set Error | Gb_err | -2 | 0 | +2 | dB | Gain=-20dB to +20dB f=100Hz | | |
| щ | Maximum Boost Gain | G _{M_BST} | 18 | 20 | 22 | dB | Gain=+20dB f=1kHz V _{IN} =100mVrms G _M =20log (V _{OUT} /V _{IN}) | | |
| MIDDLE | Maximum Cut Gain | G м_сит | -22 | -20 | -18 | dB | Gain=-20dB f=1kHz V _{IN} =2Vrms G _M =20log (V _{OUT} /V _{IN}) | | |
| | Gain Set Error | Gm_err | -2 | 0 | +2 | dB | Gain=-20dB to +20dB f=1kHz | | |
| ш | Maximum Boost Gain | G _{T_BST} | 18 | 20 | 22 | dB | Gain=+20dB f=10kHz V _{IN} =100mVrms Gτ=20log (V _{OUT} /V _{IN}) | | |
| TREBLE | Maximum Cut Gain | Gt_cut | -22 | -20 | -18 | dB | Gain=-20dB f=10kHz V _{IN} =2Vrms GT=20log (V _{OUT} /V _{IN}) | | |
| | Gain Set Error | Gt_err | -2 | 0 | +2 | dB | Gain=-20dB to +20dB f=10kHz | | |
| | Input Impedance | RIN_M | 19 | 27 | 35 | kΩ | | | |
| ð | Maximum Input Voltage | VIM_M | 2.0 | 2.2 | - | Vrms | V _{IM} at THD+N(V _{OUT})=1% BW=400Hz-30KHz | | |
| MIXING | Maximum Attenuation * | GMX_MIN | - | -100 | -85 | dB | MIX=OFF Gмx=20log(V _{OUT} /VіN) BW=INF-A | | |
| | Maximum Gain | Gмх_мах | 5 | 7 | 9 | dB | ATT=+7dB G _{MX} =20log(V _{OUT} /V _{IN}) | | |

Electrical Characteristics - continued

| BLOCK | Parameter | Symbol | Limit | | | Unit | Conditions |
|-----------|-------------------------|---------------------|-------|------|-----|------|---|
| BLC | Parameter | Symbol | Min | Тур | Max | Unit | Conditions |
| | Maximum Boost Gain | G _{F_BST} | 13 | 15 | 17 | dB | Fader=15dB V _{IN} =100mVrms G _F =20log(V _{OUT} /V _{IN}) |
| SUBWOOFER | Maximum Attenuation * | GF_MIN | - | -100 | -90 | dB | $\label{eq:GF} \begin{array}{l} Fader = -\infty dB \\ G_F = 20 log(V_OUT/V_IN) \\ BW = IHF-A \end{array}$ |
| BWG | Gain Set Error | Gf_err | -2 | 0 | +2 | dB | GAIN=+1dB to +15dB |
| / SU | Attenuation Set Error 1 | GF_err1 | -2 | 0 | +2 | dB | ATT=-1dB to -15dB |
| FADER | Attenuation Set Error 2 | Gf_err2 | -3 | 0 | +3 | dB | ATT=-16dB to -47dB |
| FAD | Attenuation Set Error 3 | G _{F_ERR3} | -4 | 0 | +4 | dB | ATT=-48dB to -79dB |
| | Output Impedance | Rout | - | - | 50 | Ω | V _{IN} =100mVrms |
| | Maximum Output Voltage | V _{ом} | 2 | 2.2 | - | Vrms | THD+N=1% BW=400Hz-30KHz |

VP-9690A(Average value detection, effective value display) filter by Matsushita Communication is used for * measurement. Phase between input / output is same.

Typical Performance Curves

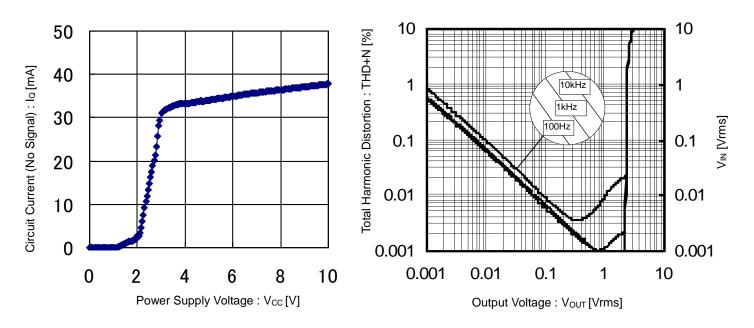


Figure 1. Circuit Current (No Signal) vs Power Supply Voltage

Figure 2. Total Harmonic Distortion vs Output Voltage

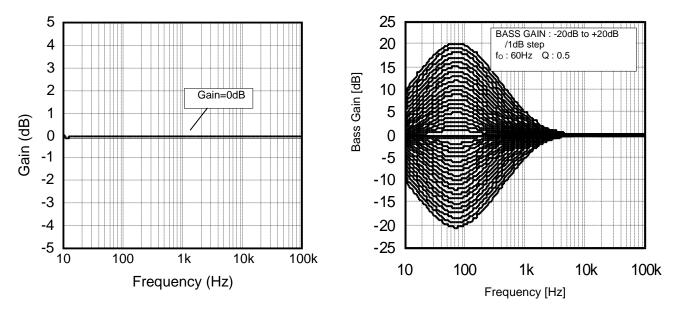


Figure 3. Gain vs Frequency

Figure 4. Bass Gain vs Frequency

Typical Performance Curves – continued

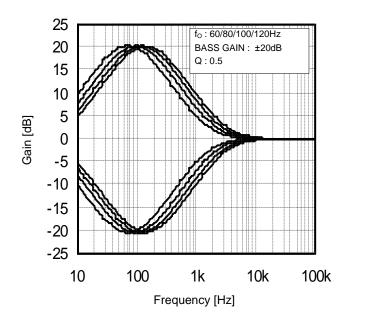
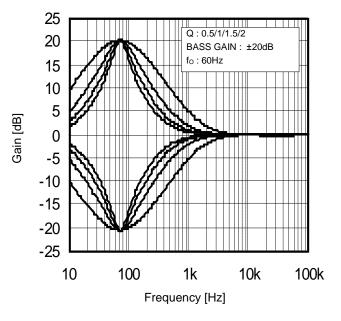
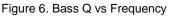


Figure 5. Bass fo vs Frequency





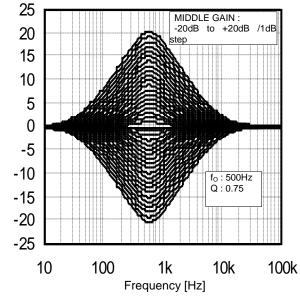


Figure 7. Middle Gain vs Frequency

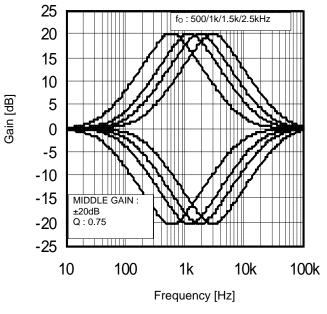
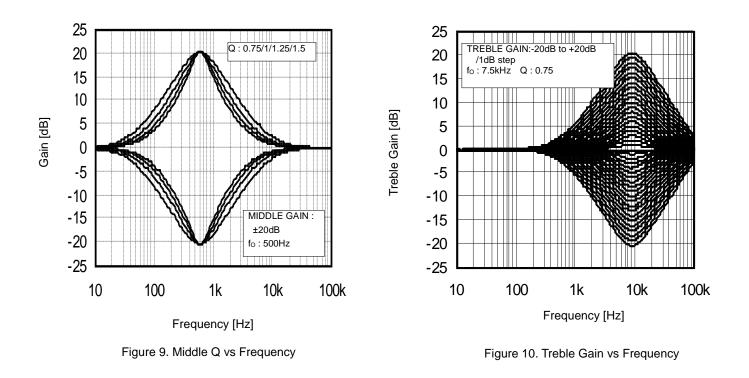


Figure 8. Middle fo vs Frequency

Middle Gain [dB]

Typical Performance Curves – continued



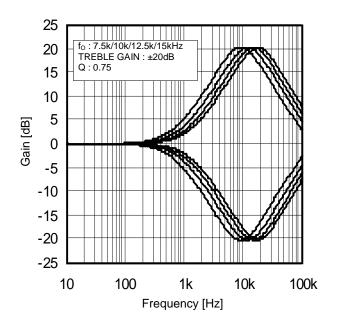


Figure 11. Treble fo vs Frequency

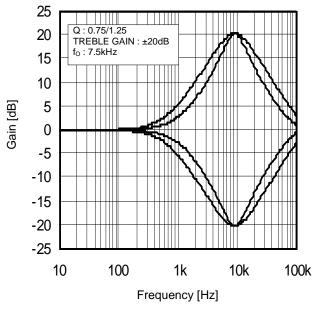


Figure 12. Treble Q vs Frequency

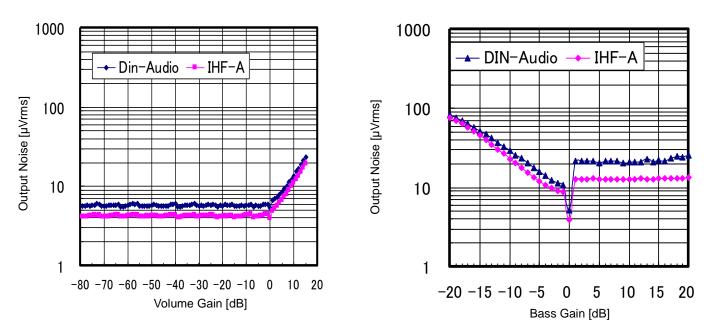
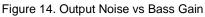


Figure 13. Output Noise vs Volume Gain

Figure 15. Output Noise vs Middle Gain



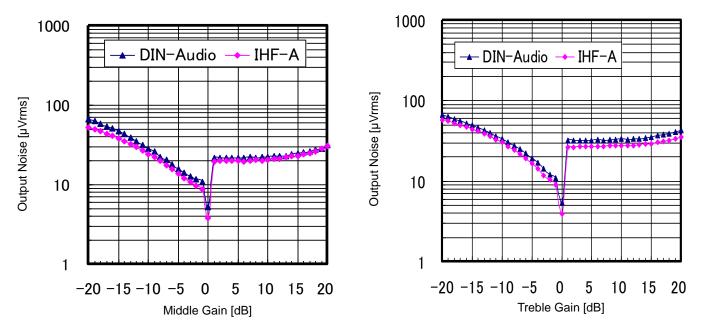


Figure 16. Output Noise vs Treble Gain

Typical Performance Curves – continued

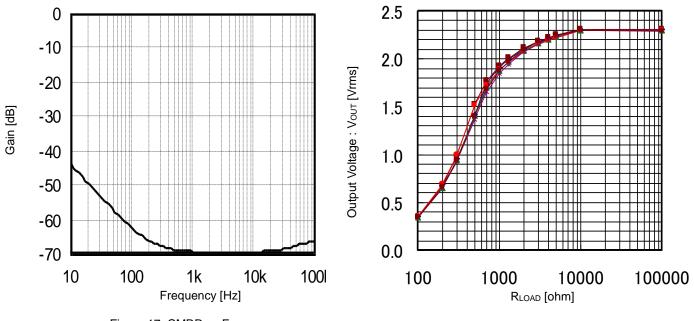
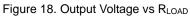


Figure 17. CMRR vs Frequency



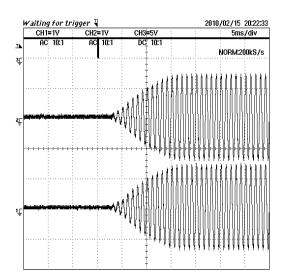


Figure 19. Advanced Switch 1

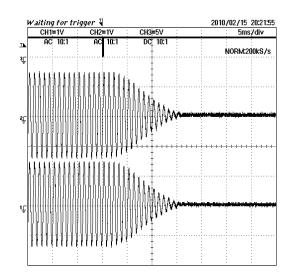


Figure 20. Advanced Switch 2

Timing Chart CONTROL SIGNAL SPECIFICATION

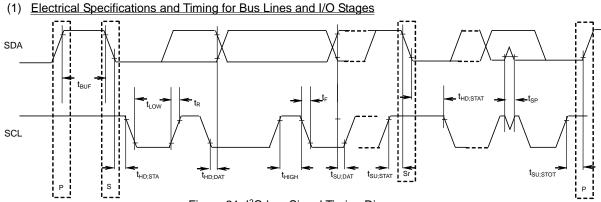


Figure 21. I²C-bus Signal Timing Diagram

| Table 1 | Characteristics of the | SDA and SCL bus lines for | r I ² C-bus devices (Ta=25°C, V _C | c=8.5V) |
|---------|------------------------|---------------------------|---|---------|
|---------|------------------------|---------------------------|---|---------|

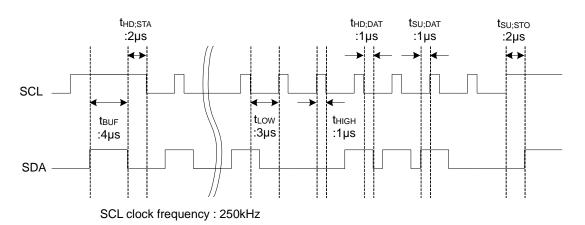
| | Parameter | Symbol | Fast-mode | Unit | |
|---|--|---------------------|-------------|------|------|
| | Falalletel | Symbol | Min | Max | Unit |
| 1 | SCL clock frequency | fscL | 0 | 400 | kHz |
| 2 | Bus free time between a STOP and START condition | t BUF | 1.3 | - | μS |
| 3 | Hold time (repeated) START condition. After this period, the first clock | t _{HD:STA} | 0.0 | | |
| 3 | pulse is generated | | 0.6 | - | μS |
| 4 | LOW period of the SCL clock | tLOW | 1.3 | - | μS |
| 5 | HIGH period of the SCL clock | tнigн | 0.6 | - | μS |
| 6 | Set-up time for a repeated START condition | t _{SU;STA} | 0.6 | - | μS |
| 7 | Data hold time: | thd;dat | 0.06 (Note) | - | μS |
| 8 | Data set-up time | tsu;dat | 120 | - | ns |
| 9 | Set-up time for STOP condition | t _{su;sтo} | 0.6 | - | μS |

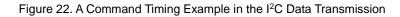
All values refer to VIH Min and VIL Max Levels (see Table 2).

(Note) A device must internally provide a hold time of at least 300 ns for the SDA signal (referred to the VIH Min of the SCL signal) in order to bridge the undefined region of the falling edge of SCL. For 7(tHD;DAT), 8(tsu;DAT), make the setup in which the margin is full.

Table 2 Characteristics of the SDA and SCL I/O stages for I²C-bus devices

| | Parameter | Symbol | Fast-mode | Unit | |
|----|---|-----------------|-----------|------|------|
| | Falamelei | Symbol | Min | Max | Unit |
| 10 | LOW level input voltage: | VIL | -0.3 | +1 | V |
| 11 | HIGH level input voltage: | Vін | 2.3 | 5 | V |
| 12 | Pulse width of spikes which must be suppressed by the input filter. | t _{SP} | 0 | 50 | ns |
| 13 | LOW level output voltage: at 3mA sink current | Vol1 | 0 | 0.4 | V |
| 14 | Input current each I/O pin with an input voltage between 0.4V and 4.5V. | h | -10 | +10 | μA |





(2) <u>I²C BUS FORMAT</u>

| | MSB LSB | MSB | LSB | MSB | LSB | | | |
|------|---|-------------------|----------------------|------------------|---------------|------|--|--|
| S | Slave Address | A Select | Address A | Data | А | Р | | |
| 1bit | 8bit | | 8bit 1bit | 8bit | 1bit | 1bit | | |
| | S | = Start condition | n (Recognition of | start bit) | | | | |
| | Slave Address = Recognition of slave address. The first 7 bits correspond to the slave address. | | | | | | | |
| | | The least sign | ificant bit is "L" w | hich corresponds | to write mode | э. | | |
| | А | = ACKNOWLED | OGE bit (Recognit | ion of acknowled | gement) | | | |
| | Select Address = Select address corresponding to volume, bass or treble. | | | | | | | |
| | Data = Data on every volume and tone. | | | | | | | |
| | Р | = Stop condition | (Recognition of | stop bit) | | | | |

(3) <u>I²C BUS Interface Protocol</u>

| (a) | Basic Format | | | | | | | | | |
|-----|--------------|-----|---|----------|--------|---|------|-----|---|---|
| S | Slave Addre | ess | Α | Select A | ddress | Α | Da | ta | Α | Ρ |
| | MSB | LSB | | MSB | LSB | Ν | /ISB | LSE | 3 | |

(b) Automatic Increment (Select Address increases (+1) according to the number of data.)

| | S | Slave A | Address | А | Select A | ddress | А | Data | a1 | А | Data2 | А | | DataN | А | Ρ |
|---|-------|---------|---------|---|----------|--------|-----|------|-----|---|-------|----|---|-------|----|---|
| | 1 | MSB | LSE | 3 | MSB | LSE | 3 1 | MSB | LSE | 3 | MSB | LS | В | MSB | LS | В |
| (| (Exar | nple) | | | | | | | | | | | | | | |

Data1 shall be set as data of address specified by Select Address.
 Data2 shall be set as data of address specified by Select Address +1.

③ DataN shall be set as data of address specified by Select Address +N-1.

(c) Configuration Unavailable for Transmission (In this case, only Select Address1 is set.)

 S
 Slave Address
 A
 Select Address1
 A
 Data
 A
 Select Address1
 Select Address1
 A
 Select Address1
 A
 Select Address1
 Select Address1

| S | SI | ave Address | Α | Select Ad | dress1 | А | Data | a | А | Select | Addres | ss 2 | А | Dat | ta | А | Ρ |
|---|------|---------------|------|---------------|-----------|------|---------|------|-------|------------|------------|--------|-----|-----|----|---|---|
| Ν | /ISB | LS | βB | MSB | LSB | | MSB | LS | В | MSB | | LSB | N | ISB | LS | В | |
| | | (Note) If any | data | a is transmit | ted as Se | elec | ct Addı | ress | ; 2 r | next to da | ata, it is | s reco | gni | zed | | | |
| | | as d | ata, | not as Sele | ct Addres | ss 2 | 2. | | | | | | | | | | |

(4) Slave Address

| Ν | MSB | | | | | | | LSB | |
|---|------------|----|----|----|----|----|----|-----|-----|
| | A6 | A5 | A4 | A3 | A2 | A1 | A0 | R/W | |
| | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 80H |

(5) Select Address & Data

| Itomo | Select Address | MSB | | | Da | ata | | | LSB | | |
|-----------------|-------------------|------------------------------|--------------------------|-------------------------|--|-------------------|---------------|-------------|---------------------|--|--|
| Items | (hex) | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | | |
| Initial setup 1 | 01 | Advanced switch ON/OFF | 0 | Input Gai Tone/Fader | witch time of n/Volume /Super Bass ting | 0 | 1 | | switch time Aute | | |
| Initial setup 2 | 02 | LPF Phase | 0 | | er Output lect | 0 | Su | ibwoofer LP | F f _C | | |
| Initial setup 3 | 03 | Front HPF Pass | Rear HPF Pass | Fro | nt / Rear HP | PF f _C | 0 1 0 | | | | |
| Input Selector | 05 | Full-diff Type | 0 | 0 | | | Input selecto | or | | | |
| Input gain | 06 | Mute ON/OFF | 0 | 0 | | Input Gain | | | | | |
| Volume gain | 20 | | - | ١ | /olume Gain | / Attenuatio | n | | | | |
| Fader 1ch Front | 28 | | Fader Gain / Attenuation | | | | | | | | |
| Fader 2ch Front | 29 | Fader Gain / Attenuation | | | | | | | | | |
| Fader 1ch Rear | 2A | | | | Fader Gain | / Attenuatio | า | | | | |
| Fader 2ch Rear | 2B | | | | Fader Gain | / Attenuatio | า | | | | |
| Fader Subwoofer | 2C | | | | Fader Gain | / Attenuatio | า | | | | |
| Mixing | 30 | | | | Mixing Gain | / Attenuatio | n | | | | |
| Bass setup | 41 | 0 | 0 | Bas | s fo | 0 | 0 | Bas | ss Q | | |
| Middle setup | 44 | 0 | 0 | Mido | lle fo | 0 | 0 | Mide | dle Q | | |
| Treble setup | 47 | 0 | 0 | Treb | le fo | 0 | 0 | 0 | Treble Q | | |
| Bass gain | 51 | Bass Boost/ Cut | 0 | 0 | | | Bass Gain | | | | |
| Middle gain | 54 | Middle Boost/ Cut | 0 | 0 0 Middle Gain | | | | | | | |
| Treble gain | 57 | Treble Boost/ Cut | 0 | 0 | | | Treble Gain | l | | | |
| Super Bass Gain | 75 | 0 | 0 | 0 | | Si | uper Bass G | ain | | | |
| System Reset | FE | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | | |

Advanced switch

Note

- 1. The Advanced Switch works in the latch part while changing from one function to another.
- 2. Upon continuous data transfer, the Select Address rolls over because of the automatic increment function, as shown below.

$$\rightarrow 01 \rightarrow 02 \rightarrow 03 \rightarrow 05 \rightarrow 06 \rightarrow 20 \rightarrow 28 \rightarrow 29 \rightarrow 2A \rightarrow 2B \rightarrow 2C$$

$$\rightarrow 30 \rightarrow 41 \rightarrow 44 \rightarrow 47 \rightarrow 51 \rightarrow 54 \rightarrow 57 \rightarrow 75$$

- 3. Advanced switch is not used for the function of input selector and subwoofer output select, etc. Therefore, please apply mute on the side when changing these settings.
- 4. When using mute function of this IC at the time of changing input selector, please switch mute ON/OFF for waiting advanced-mute time.

|--|

| Time | MSB | Advanced switch time of Mute | | | | | | | |
|---------|--------------------|------------------------------|-------------|-------------|----|----|----|----|--|
| TIIIIC | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | |
| 0.6msec | Advonced | | Advanced | switch time | | | 0 | 0 | |
| 1.0msec | Advanced Switch | 0 | of Input ga | ain/Volume | 0 | 1 | 0 | 1 | |
| 1.4msec | ON/OFF | 0 | | ler/Super | 0 | 1 | 1 | 0 | |
| 3.2msec | UN/OFF | | Bass/ | Mixing | | | 1 | 1 | |

| Time | MSB | Super Bass/Mixing | | | | | | | | | | | |
|-----------|--------------------|-------------------|----|----|----|----|-----------------|---------|--|--|--|--|--|
| | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | | | | | |
| 4.7 msec | Advonced | | 0 | 0 | | | | | | | | | |
| 7.1 msec | Advanced Switch | 0 | 0 | 1 | 0 | 1 | Advanced switch | | | | | | |
| 11.2 msec | ON/OFF | 0 | 1 | 0 | U | I | Time | of Mute | | | | | |
| 14.4 msec | | | 1 | 1 | | | | | | | | | |

| Mode | MSB | | Advan | ced s | witch (| ON/OF | F | LSB |
|------|-----|----|-------------|---------------------------|---------|-------|--------|-----------|
| Mode | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| OFF | 0 | 0 | of Input ga | switch time ain/Volume | 0 | 1 | | ed switch |
| ON | 1 | Ū | | ler/Super Mixing | 0 | - | Time o | of Mute |

Select address 02(hex)

| fa | MSB | | Su | bwoot | fer LP | F fc | | LSB | | | |
|-------------|-------|----|---------|-----------|--------|------|---------------|-----|--|--|--|
| fc | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | | | |
| OFF | | | | | | 0 | 0 | 0 | | | |
| 55Hz | | | | | | 0 | 0 | 1 | | | |
| 85Hz | LPF | 0 | Subwoof | er Output | 0 | 0 | 1 | 0 | | | |
| 120Hz | Phase | 0 | Se | lect | 0 | 0 | 1 | 1 | | | |
| 160Hz | | | | | | 1 | 0 | 0 | | | |
| Prohibition | | | | | | (| Other setting | g | | | |

| Mode | MSB | : | Subwo | oofer (| Dutput | Selec | ct | LSB |
|-------------|-------|----|-------|---------|--------|-----------------------|----|-----|
| Mode | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| LPF | | | 0 | 0 | | | | • |
| Front | LPF | 0 | 0 | 1 | | Subwoofer LPF f_{C} | | |
| Rear | Phase | 0 | 1 | 0 | 0 | | | |
| Prohibition | | | 1 | 1 | | | | |

| Phase | MSB | | | | LSB | | | |
|--------|-----|----|---------|-----------|-----|-----|-------------|------|
| Flidse | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| 0° | 0 | 0 | Subwoof | er output | 0 | S., | bwoofer LPI | = fo |
| 180° | 1 | 0 | sel | lect | 0 | Su | | |

Select address 03(hex)

| Mode | MSB | | Fro | nt/Rea | ar HPI | F fc | LSB | |
|-------------|-------|------|-----|---------------|--------|------|-----|----|
| Mode | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| 55Hz | | | 0 | 0 | 0 | | | |
| 85Hz | Front | Rear | 0 | 0 | 1 | | | |
| 120Hz | HPF | HPF | 1 | 1 | 0 | 0 | 1 | 0 |
| 160Hz | Pass | Pass | 0 | 1 | 0 | | | |
| Prohibition | | | (| Other setting | 9 | | | |

| Mode | MSB | MSB Rear HPF | | | | | | | |
|----------|-------------|--------------|-----------------------|--------------|------------|----|----|----|--|
| iviode | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | |
| pass | Front | 0 | F ₁ | | - 4 | 0 | | 0 | |
| NOT pass | HPF Pass | 1 | Fro | ont/Rear HPI | F TC | 0 | 1 | 0 | |

| Mode | MSB | | | Front | | LSB | | |
|----------|-----|-------------|-----------------------|-------|-----|-----|----|----|
| Mode | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| pass | 0 | Rear | Г | | - 4 | 0 1 | 4 | 0 |
| NOT pass | 1 | HPF Pass | Front/Rear HPF fc 0 1 | | | | | U |

Select address 05(hex)

| Mode | | | MSB | | In | put S | electo | or | | LSB | | | | | | | | |
|----------|-------------|-------|--------------------|----|----|-------|--------|--------------|----|-----|--|--|--|---|---|---|---|---|
| wode | OUTF1 | OUTF2 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | | | | | | | | |
| Α | A1 | A2 | | | | 0 | 0 | 0 | 0 | 0 | | | | | | | | |
| В | B1 | B2 | | | | 0 | 0 | 0 | 0 | 1 | | | | | | | | |
| С | C1 | C2 | | | | 0 | 0 | 0 | 1 | 0 | | | | | | | | |
| D single | DP1 | DP2 | Full- diff bias | | | 0 | 0 | 0 | 1 | 1 | | | | | | | | |
| E single | EP1 | EP2 | | 0 | | 0 | 0 | 1 | 0 | 0 | | | | | | | | |
| A diff | A1 | B1 | | | 0 | 0 | 1 | 1 | 1 | 1 | | | | | | | | |
| C diff | B2 | C2 | type select | | | 1 | 0 | 0 | 0 | 0 | | | | | | | | |
| D diff | DP1 | DP2 | 361601 | | | 0 | 0 | 1 | 1 | 0 | | | | | | | | |
| E diff | EP1 | EP2 | | | | | | | | | | | | 0 | 0 | 1 | 1 | 1 |
| Inp | out SHOR | RΤ. | | | | 0 | 1 | 0 | 0 | 1 | | | | | | | | |
| P | Prohibitior | 1 | | | | | C | ther setting | g | | | | | | | | | |

Input SHORT : The input impedance of each input terminal is lowered from $100k\Omega(Typ)$ to $6 k\Omega(Typ)$. (For quick charge of coupling capacitor)

BD37544FS

| 201000 | address 05(hex) | MSB | F | | f Bias | Туре | Selec | t | LSB |
|--------|---------------------|---------------|----|--------------------------------|----------|---------------------|--------------|-----------------|------|
| | Mode | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| | Negative Input | 0 | 0 | 0 | | | nput Selecto | or | |
| | Bias | 1 | - | - | | - | | - | |
| | Negative input typ | be | | 1ch 1ch signal inp | out | ▶ ‡+ | EP1 | 1ch | |
| | For Ground –isola | ation type. | | | | И+ | EN1 | Different | ial |
| | | | | | | | EN2 | | |
| | | | | | - | <u>↓</u> <u> </u> + | -12 | 2ch | |
| | | | | 2ch 2ch signal inp | - | ,, ▶[]+ | EP2 13 | Different | ial |
| | Bias type | | | | | | EP1 | | |
| | For differential am | nplifier type | | | | ▶+ | -10 | 1ch | |
| | | | | 1ch 1ch signal input | \sim | . 141 | EN1 | Differen | tial |
| | | | | | | | | | |
| | | | | | | ► | EN2 | | |
| | | | | 2ch | V | ► И | EP2 | 2ch Differen | tial |
| | | | | 2ch signal input | | ▶∄⁺ | 13 | - | |

Select address 06 (hex)

| Gain | MSB | | - | Inpu | it Gair | <u>ו</u> | | LSB | |
|-------------|--------|----|----|------|---------|----------|-----|-----|---|
| Gain | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | |
| 0dB | | | | 0 | 0 | 0 | 0 | 0 | |
| 1dB | | | | 0 | 0 | 0 | 0 | 1 | |
| 2dB | | | | 0 | 0 | 0 | 1 | 0 | |
| 3dB | | | | 0 | 0 | 0 | 1 | 1 | |
| 4dB | | | | 0 | 0 | 1 | 0 | 0 | |
| 5dB | | | | 0 | 0 | 1 | 0 | 1 | |
| 6dB | | | | 0 | 0 | 1 | 1 | 0 | |
| 7dB | | | | 0 | 0 | 1 | 1 | 1 | |
| 8dB | | | | 0 | 1 | 0 | 0 | 0 | |
| 9dB | | | 0 | | 0 | 1 | 0 | 0 | 1 |
| 10dB | | | | 0 | 1 | 0 | 1 | 0 | |
| 11dB | Mute | 0 | | 0 | 1 | 0 | 1 | 1 | |
| 12dB | ON/OFF | | | 0 | 1 | 1 | 0 | 0 | |
| 13dB | | | | 0 | 1 | 1 | 0 | 1 | |
| 14dB | | | | 0 | 1 | 1 | 1 | 0 | |
| 15dB | | | | 0 | 1 | 1 | 1 | 1 | |
| 16dB | | | | 1 | 0 | 0 | 0 | 0 | |
| 17dB | | | | 1 | 0 | 0 | 0 | 1 | |
| 18dB | | | | 1 | 0 | 0 | 1 | 0 | |
| 19dB | | | | 1 | 0 | 0 | 1 | 1 | |
| 20dB | | | | 1 | 0 | 1 | 0 | 0 | |
| | | | | 1 | 1 | 0 | 1 | 1 | |
| Prohibition | | | | | | | | : | |
| | | | | . 1 | . 1 | 1 | . 1 | . 1 | |

: Initial condition

Г

Select address 06 (hex)

| Mode | MSB | 3 Mute ON/OFF LS | | | | | | | | |
|------|-----|------------------|----|------------|----|------------|----|----|--|--|
| Wode | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | | |
| OFF | 0 | 0 | 0 | | | Innut Cain | | | | |
| ON | 1 | 0 | 0 | Input Gain | | | | | | |

Select address 20, 28, 29, 2A, 2B, 2C (hex)

| Gain & ATT | MSB | Vo | I, Fad | er Gai | n / Att | enuati | ion | LSB |
|-------------|-----|----|--------|--------|---------|--------|-----|-----|
| Gain & ATT | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 |
| Prohibition | : | : | : | : | : | : | : | : |
| | 0 | 1 | 1 | 1 | 0 | 0 | 0 | 0 |
| 15dB | 0 | 1 | 1 | 1 | 0 | 0 | 0 | 1 |
| 14dB | 0 | 1 | 1 | 1 | 0 | 0 | 1 | 0 |
| 13dB | 0 | 1 | 1 | 1 | 0 | 0 | 1 | 1 |
| : | : | : | : | : | : | : | : | : |
| -77dB | 1 | 1 | 0 | 0 | 1 | 1 | 0 | 1 |
| -78dB | 1 | 1 | 0 | 0 | 1 | 1 | 1 | 0 |
| -79dB | 1 | 1 | 0 | 0 | 1 | 1 | 1 | 1 |
| | 1 | 1 | 0 | 1 | 0 | 0 | 0 | 0 |
| Prohibition | : | : | : | : | : | : | : | : |
| | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 0 |
| -∞dB | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |

Select address 30(hex)

| Gain & ATT | MSB | Г | Mixing | Gain | / Atter | nuation | า | LSB |
|-------------|-----|----|--------|------|---------|---------|----|-----|
| Gain & ATT | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 |
| Prohibition | : | : | : | : | : | : | : | : |
| | 0 | 1 | 1 | 1 | 1 | 0 | 0 | 0 |
| 7dB | 0 | 1 | 1 | 1 | 1 | 0 | 0 | 1 |
| 6dB | 0 | 1 | 1 | 1 | 1 | 0 | 1 | 0 |
| 5dB | 0 | 1 | 1 | 1 | 1 | 0 | 1 | 1 |
| : | : | : | : | : | : | : | : | : |
| -77dB | 1 | 1 | 0 | 0 | 1 | 1 | 0 | 1 |
| -78dB | 1 | 1 | 0 | 0 | 1 | 1 | 1 | 0 |
| -79dB | 1 | 1 | 0 | 0 | 1 | 1 | 1 | 1 |
| | 1 | 1 | 0 | 1 | 0 | 0 | 0 | 0 |
| Prohibition | : | : | : | : | : | : | : | : |
| · | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 0 |
| MIX OFF | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |

(Note) See the precaution on P30 together, too.

Select address 41(hex)

| Q factor | MSB | | В | Bass | | Q factor | | LSB |
|----------|-----|----|-----|-------------------|----|----------|----|-----|
| QTACION | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| 0.5 | | | | | | | 0 | 0 |
| 1.0 | 0 | 0 | Por | o f | 0 | 0 | 0 | 1 |
| 1.5 | 0 | 0 | Das | ss f _O | | | 1 | 0 |
| 2.0 | | | | | | | 1 | 1 |

| fa | MSB | | | Bass f _o | | | | | |
|-------|-----|----|----|---------------------|----|----|------------------|----|--|
| 10 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | |
| 60Hz | | | 0 | 0 | | | | | |
| 80Hz | | 0 | 0 | 1 | 0 | 0 | Bass Q factor | | |
| 100Hz | 0 | | 1 | 0 | 0 | 0 | | | |
| 120Hz | | | 1 | 1 | | | | | |

Select address 44(hex)

| Q factor | MSB | | Mi | Middle | | Q factor | | LSB |
|----------|-----|----|-----------|--------|----|----------|----|-----|
| QTACION | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| 0.75 | | | | | | | 0 | 0 |
| 1.0 | 0 | 0 | Middle fo | | 0 | 0 | 0 | 1 |
| 1.25 | U | | | | | | 1 | 0 |
| 1.5 | | | | | | | 1 | 1 |

| fo | MSB | | | Midd | LSB | | | |
|--------|-----|----|----|------|-----|----|--------------------|----|
| 10 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| 500Hz | | | 0 | 0 | 0 | 0 | Middle Q factor | |
| 1kHz | 0 | 0 | 0 | 1 | | | | |
| 1.5kHz | | | 1 | 0 | | 0 | | |
| 2.5kHz | | | 1 | 1 | | | | |

Select address 47 (hex)

| Q factor | MSB | | Т | ctor | | LSB | | |
|----------|-----|----|------|--------|----|-----|----|----|
| QTACION | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| 0.75 | 0 | 0 | Troh | lo fe | 0 | 0 | 0 | 0 |
| 1.25 | 0 | 0 | Trec | ole fo | 0 | 0 | 0 | 1 |

| fo | MSB | | | Treble fo | | | | | |
|---------|-----|----|----|-----------|----|----|----|----------|--|
| TO | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | |
| 7.5kHz | | | 0 | 0 | | | | | |
| 10kHz | | 0 | 0 | 1 | 0 | 0 | 0 | Treble | |
| 12.5kHz | 0 | 0 | 1 | 0 | 0 | 0 | 0 | Q factor | |
| 15kHz | | | 1 | 1 | | | | | |

| Cain | MSB | | Bass/I | Middle | e/Trebl | e Gaiı | n | LSE |
|-------------|---------|----|--------|--------|---------|--------|----|-----|
| Gain | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| 0dB | | | | 0 | 0 | 0 | 0 | 0 |
| 1dB | | | | 0 | 0 | 0 | 0 | 1 |
| 2dB | | | | 0 | 0 | 0 | 1 | 0 |
| 3dB | | | | 0 | 0 | 0 | 1 | 1 |
| 4dB | | | | 0 | 0 | 1 | 0 | 0 |
| 5dB | | | | 0 | 0 | 1 | 0 | 1 |
| 6dB | | | | 0 | 0 | 1 | 1 | 0 |
| 7dB | | | | 0 | 0 | 1 | 1 | 1 |
| 8dB | | | | 0 | 1 | 0 | 0 | 0 |
| 9dB | | | | 0 | 1 | 0 | 0 | 1 |
| 10dB | Bass/ | | | 0 | 1 | 0 | 1 | 0 |
| 11dB | Middle/ | | | 0 | 1 | 0 | 1 | 1 |
| 12dB | Treble | 0 | 0 | 0 | 1 | 1 | 0 | 0 |
| 13dB | Boost | Ū. | C C | 0 | 1 | 1 | 0 | 1 |
| 14dB | /cut | | | 0 | 1 | 1 | 1 | 0 |
| 15dB | | | | 0 | 1 | 1 | 1 | 1 |
| 16dB | | | | 1 | 0 | 0 | 0 | 0 |
| 17dB | | | | 1 | 0 | 0 | 0 | 1 |
| 18dB | | | | 1 | 0 | 0 | 1 | 0 |
| 19dB | | | | 1 | 0 | 0 | 1 | 1 |
| 20dB | | | | 1 | 0 | 1 | 0 | 0 |
| | | | | 1 | 0 | 1 | 0 | 1 |
| Prohibition | | | | : | : | : | : | : |
| TOTIDITION | | | | 1 | 1 | 1 | 1 | 0 |
| | | | | 1 | 1 | 1 | 1 | 1 |

| Mode | MSB | SB Bass/Middle/Treble Boost/Cut | | | | | | | |
|-------|-----|---------------------------------|----|-------------------------|--------|--------|--------|----|--|
| woue | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | |
| Boost | 0 | 0 | 0 | Bass/Middle/Treble Gain | | a Cain | | | |
| Cut | 1 | 0 | 0 | | Da55/1 | | e Gain | | |

| Gain | MSB | | Su | iper B | ass G | ain | | LSE |
|-------------|-----|----|----|--------|-------|-----|----|-----|
| Gain | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| 0dB | | | | 0 | 0 | 0 | 0 | 0 |
| 1dB | | | | 0 | 0 | 0 | 0 | 1 |
| 2dB | | | | 0 | 0 | 0 | 1 | 0 |
| 3dB | | | | 0 | 0 | 0 | 1 | 1 |
| 4dB | | | | 0 | 0 | 1 | 0 | 0 |
| 5dB | | | | 0 | 0 | 1 | 0 | 1 |
| 6dB | | | | 0 | 0 | 1 | 1 | 0 |
| 7dB | | | | 0 | 0 | 1 | 1 | 1 |
| 8dB | | | | 0 | 1 | 0 | 0 | 0 |
| 9dB | | | | 0 | 1 | 0 | 0 | 1 |
| 10dB | | | | 0 | 1 | 0 | 1 | 0 |
| 11dB | | - | _ | 0 | 1 | 0 | 1 | 1 |
| 12dB | 0 | 0 | 0 | 0 | 1 | 1 | 0 | 0 |
| 13dB | | | | 0 | 1 | 1 | 0 | 1 |
| 14dB | | | | 0 | 1 | 1 | 1 | 0 |
| 15dB | | | | 0 | 1 | 1 | 1 | 1 |
| 16dB | | | | 1 | 0 | 0 | 0 | 0 |
| 17dB | | | | 1 | 0 | 0 | 0 | 1 |
| 18dB | | | | 1 | 0 | 0 | 1 | 0 |
| 19dB | | | | 1 | 0 | 0 | 1 | 1 |
| 20dB | | | | 1 | 0 | 1 | 0 | 0 |
| | | | | 1 | 0 | 1 | 0 | 1 |
| Prohibition | | | | : | : | : | : | : |
| | | | | 1 | 1 | 1 | 1 | 1 |

(Note) About Super Bass, the above Gain is for in indication purposes. Actual Gain (=20log (V_{OUT}/V_{IN})) is different. Refer to P31 to P34 for the details.

: Initial condition

(6) About Power ON Reset

Built-in IC initialization is made during power ON of the supply voltage. Please send initial data to all addresses at supply voltage on. And please turn ON mute until this initial data is sent.

| Parameter | Symbol | | Limit | | Unit | Conditions | | |
|---|--------|-----|-------|-----|------|----------------------------------|--|--|
| Falameter | Symbol | Min | Тур | Max | Unit | | | |
| Rise Time of VCC | trise | 33 | - | - | µsec | V_{CC} rise time from 0V to 5V | | |
| VCC Voltage of Release Power ON Reset | Vpor | - | 4.1 | - | V | | | |

Application Information

1. Function and Specifications

| Function and Specifica | Specifications | | | | | | | | | | |
|------------------------|--|--|--|--|--|--|--|--|--|--|--|
| | Stereo input | | | | | | | | | | |
| | Single-End/Differential | | | | | | | | | | |
| | (Possible to set the number of single-end/ differential as follows) | | | | | | | | | | |
| Input selector | Single-End Differential | | | | | | | | | | |
| | Mode 1 0 4 Mode 2 1 3 | | | | | | | | | | |
| | Mode 3 3 2 | | | | | | | | | | |
| | Mode 4 4 1 | | | | | | | | | | |
| | Mode 5 5 0 Table.1 Combination of input selector | | | | | | | | | | |
| | +20dB to 0dB (1dB step) | | | | | | | | | | |
| Input gain | Possible to use "Advanced switch" for prevention of switching noise. | | | | | | | | | | |
| Mute | Possible to use "Advanced switch" for prevention of switching noise. | | | | | | | | | | |
| Volume | +15dB to -79dB (1dB step), -∞dB | | | | | | | | | | |
| volume | Possible to use "Advanced switch" for prevention of switching noise. | | | | | | | | | | |
| | • +20dB to -20dB (1dB step) | | | | | | | | | | |
| Bass | · Q=0.5, 1, 1.5, 2 | | | | | | | | | | |
| Duss | • f ₀ =60, 80, 100, 120Hz | | | | | | | | | | |
| | Possible to use "Advanced switch" for prevention of switching noise. | | | | | | | | | | |
| | +20dB to -20dB (1dB step) | | | | | | | | | | |
| Middle | · Q=0.75, 1, 1.25, 1.5 | | | | | | | | | | |
| | • f ₀ =500, 1k, 1.5k 2.5kHz | | | | | | | | | | |
| | Possible to use "Advanced switch" for prevention of switching noise. | | | | | | | | | | |
| | +20dB to -20dB (1dB step) | | | | | | | | | | |
| Treble | • Q=0.75, 1.25 | | | | | | | | | | |
| | • f ₀ =7.5k, 10k, 12.5k, 15kHz | | | | | | | | | | |
| | Possible to use "Advanced switch" for prevention of switching noise. | | | | | | | | | | |
| Fader | +15dB to -79dB(1dB step), -∞dB | | | | | | | | | | |
| | Possible to use "Advanced switch" for prevention of switching noise. | | | | | | | | | | |
| LPF | • fc=55/85/120/160Hz, pass | | | | | | | | | | |
| | Phase shift (0°/180°) | | | | | | | | | | |
| HPF | • fc=55/85/120/160Hz, pass | | | | | | | | | | |
| | Monaural input | | | | | | | | | | |
| Mixing | +7dBdB to -79dB (1dB step), -∞dB | | | | | | | | | | |
| | Possible to use "Advanced switch" for prevention of switching noise. | | | | | | | | | | |
| Super Bass | +20dB to 0dB (1dB step) | | | | | | | | | | |
| | Possible to use "Advanced switch" for prevention of switching noise. | | | | | | | | | | |

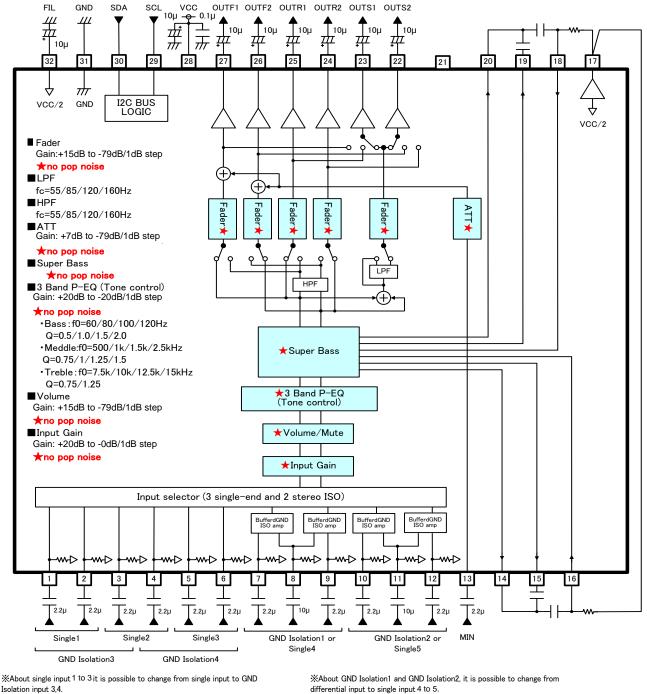
2. Volume / Fader Volume / Mixing ATT Attenuation Data

| (dB) | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | (dB) | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|------|----|----|----|----|----|----|----|----|------|----|----|----|----|----|----|----|----|
| +15 | 0 | 1 | 1 | 1 | 0 | 0 | 0 | 1 | -33 | 1 | 0 | 1 | 0 | 0 | 0 | 0 | 1 |
| +14 | 0 | 1 | 1 | 1 | 0 | 0 | 1 | 0 | -34 | 1 | 0 | 1 | 0 | 0 | 0 | 1 | 0 |
| +13 | 0 | 1 | 1 | 1 | 0 | 0 | 1 | 1 | -35 | 1 | 0 | 1 | 0 | 0 | 0 | 1 | 1 |
| +12 | 0 | 1 | 1 | 1 | 0 | 1 | 0 | 0 | -36 | 1 | 0 | 1 | 0 | 0 | 1 | 0 | 0 |
| +11 | 0 | 1 | 1 | 1 | 0 | 1 | 0 | 1 | -37 | 1 | 0 | 1 | 0 | 0 | 1 | 0 | 1 |
| +10 | 0 | 1 | 1 | 1 | 0 | 1 | 1 | 0 | -38 | 1 | 0 | 1 | 0 | 0 | 1 | 1 | 0 |
| +9 | 0 | 1 | 1 | 1 | 0 | 1 | 1 | 1 | -39 | 1 | 0 | 1 | 0 | 0 | 1 | 1 | 1 |
| +8 | 0 | 1 | 1 | 1 | 1 | 0 | 0 | 0 | -40 | 1 | 0 | 1 | 0 | 1 | 0 | 0 | 0 |
| +7 | 0 | 1 | 1 | 1 | 1 | 0 | 0 | 1 | -41 | 1 | 0 | 1 | 0 | 1 | 0 | 0 | 1 |
| +6 | 0 | 1 | 1 | 1 | 1 | 0 | 1 | 0 | -42 | 1 | 0 | 1 | 0 | 1 | 0 | 1 | 0 |
| +5 | 0 | 1 | 1 | 1 | 1 | 0 | 1 | 1 | -43 | 1 | 0 | 1 | 0 | 1 | 0 | 1 | 1 |
| +4 | 0 | 1 | 1 | 1 | 1 | 1 | 0 | 0 | -44 | 1 | 0 | 1 | 0 | 1 | 1 | 0 | 0 |
| +3 | 0 | 1 | 1 | 1 | 1 | 1 | 0 | 1 | -45 | 1 | 0 | 1 | 0 | 1 | 1 | 0 | 1 |
| +2 | 0 | 1 | 1 | 1 | 1 | 1 | 1 | 0 | -46 | 1 | 0 | 1 | 0 | 1 | 1 | 1 | 0 |
| +1 | 0 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | -47 | 1 | 0 | 1 | 0 | 1 | 1 | 1 | 1 |
| 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | -48 | 1 | 0 | 1 | 1 | 0 | 0 | 0 | 0 |
| -1 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | -49 | 1 | 0 | 1 | 1 | 0 | 0 | 0 | 1 |
| -2 | 1 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | -50 | 1 | 0 | 1 | 1 | 0 | 0 | 1 | 0 |
| -3 | 1 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | -51 | 1 | 0 | 1 | 1 | 0 | 0 | 1 | 1 |
| -4 | 1 | 0 | 0 | 0 | 0 | 1 | 0 | 0 | -52 | 1 | 0 | 1 | 1 | 0 | 1 | 0 | 0 |
| -5 | 1 | 0 | 0 | 0 | 0 | 1 | 0 | 1 | -53 | 1 | 0 | 1 | 1 | 0 | 1 | 0 | 1 |
| -6 | 1 | 0 | 0 | 0 | 0 | 1 | 1 | 0 | -54 | 1 | 0 | 1 | 1 | 0 | 1 | 1 | 0 |
| -7 | 1 | 0 | 0 | 0 | 0 | 1 | 1 | 1 | -55 | 1 | 0 | 1 | 1 | 0 | 1 | 1 | 1 |
| -8 | 1 | 0 | 0 | 0 | 1 | 0 | 0 | 0 | -56 | 1 | 0 | 1 | 1 | 1 | 0 | 0 | 0 |
| -9 | 1 | 0 | 0 | 0 | 1 | 0 | 0 | 1 | -57 | 1 | 0 | 1 | 1 | 1 | 0 | 0 | 1 |
| -10 | 1 | 0 | 0 | 0 | 1 | 0 | 1 | 0 | -58 | 1 | 0 | 1 | 1 | 1 | 0 | 1 | 0 |
| -11 | 1 | 0 | 0 | 0 | 1 | 0 | 1 | 1 | -59 | 1 | 0 | 1 | 1 | 1 | 0 | 1 | 1 |
| -12 | 1 | 0 | 0 | 0 | 1 | 1 | 0 | 0 | -60 | 1 | 0 | 1 | 1 | 1 | 1 | 0 | 0 |
| -13 | 1 | 0 | 0 | 0 | 1 | 1 | 0 | 1 | -61 | 1 | 0 | 1 | 1 | 1 | 1 | 0 | 1 |
| -14 | 1 | 0 | 0 | 0 | 1 | 1 | 1 | 0 | -62 | 1 | 0 | 1 | 1 | 1 | 1 | 1 | 0 |
| -15 | 1 | 0 | 0 | 0 | 1 | 1 | 1 | 1 | -63 | 1 | 0 | 1 | 1 | 1 | 1 | 1 | 1 |
| -16 | 1 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | -64 | 1 | 1 | 0 | 0 | 0 | 0 | 0 | 0 |
| -17 | 1 | 0 | 0 | 1 | 0 | 0 | 0 | 1 | -65 | 1 | 1 | 0 | 0 | 0 | 0 | 0 | 1 |
| -18 | 1 | 0 | 0 | 1 | 0 | 0 | 1 | 0 | -66 | 1 | 1 | 0 | 0 | 0 | 0 | 1 | 0 |
| -19 | 1 | 0 | 0 | 1 | 0 | 0 | 1 | 1 | -67 | 1 | 1 | 0 | 0 | 0 | 0 | 1 | 1 |
| -20 | 1 | 0 | 0 | 1 | 0 | 1 | 0 | 0 | -68 | 1 | 1 | 0 | 0 | 0 | 1 | 0 | 0 |
| -21 | 1 | 0 | 0 | 1 | 0 | 1 | 0 | 1 | -69 | 1 | 1 | 0 | 0 | 0 | 1 | 0 | 1 |
| -22 | 1 | 0 | 0 | 1 | 0 | 1 | 1 | 0 | -70 | 1 | 1 | 0 | 0 | 0 | 1 | 1 | 0 |
| -23 | 1 | 0 | 0 | 1 | 0 | 1 | 1 | 1 | -71 | 1 | 1 | 0 | 0 | 0 | 1 | 1 | 1 |
| -24 | 1 | 0 | 0 | 1 | 1 | 0 | 0 | 0 | -72 | 1 | 1 | 0 | 0 | 1 | 0 | 0 | 0 |
| -25 | 1 | 0 | 0 | 1 | 1 | 0 | 0 | 1 | -73 | 1 | 1 | 0 | 0 | 1 | 0 | 0 | 1 |
| -26 | 1 | 0 | 0 | 1 | 1 | 0 | 1 | 0 | -74 | 1 | 1 | 0 | 0 | 1 | 0 | 1 | 0 |
| -27 | 1 | 0 | 0 | 1 | 1 | 0 | 1 | 1 | -75 | 1 | 1 | 0 | 0 | 1 | 0 | 1 | 1 |
| -28 | 1 | 0 | 0 | 1 | 1 | 1 | 0 | 0 | -76 | 1 | 1 | 0 | 0 | 1 | 1 | 0 | 0 |
| -29 | 1 | 0 | 0 | 1 | 1 | 1 | 0 | 1 | -77 | 1 | 1 | 0 | 0 | 1 | 1 | 0 | 1 |
| -30 | 1 | 0 | 0 | 1 | 1 | 1 | 1 | 0 | -78 | 1 | 1 | 0 | 0 | 1 | 1 | 1 | 0 |
| -31 | 1 | 0 | 0 | 1 | 1 | 1 | 1 | 1 | -79 | 1 | 1 | 0 | 0 | 1 | 1 | 1 | 1 |
| -32 | 1 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | -∞ | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |

Adjustable range of mixing ATT is +7dB to -∞dB.

: Initial condition

3. Application Circuit



3,4.

Figure 23. BD37544FS

Unit R : [Ω] C : [F]

Notes on wiring

①Please connect the decoupling capacitor of the power supply in the shortest possible distance to GND.
 ②GND lines should be one-point connected.
 ③Wiring pattern of Digital should be away from that of Analog unit and cross-talk should not be acceptable.
 ④SCL and SDA lines of I²C BUS should not be parallel if possible.

The lines should be shielded, if they are adjacent to each other.

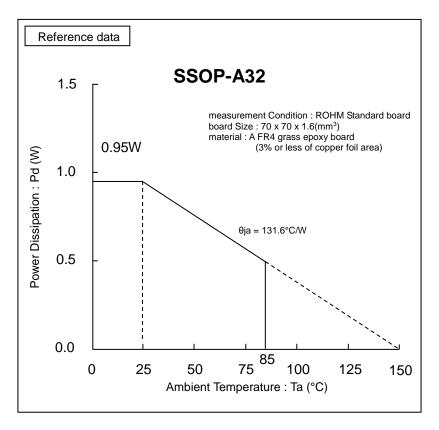
(5) Analog input lines should not be parallel if possible. The lines should be shielded, if they are adjacent.

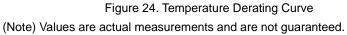
6 Please short Pins 15-16, and Pins 18-19 if the Super Bass is not used.

Power Dissipation

About the thermal design of the IC

Characteristics of an IC have a great deal to do with the temperature at which it is used, and exceeding absolute maximum ratings may degrade and destroy elements. Careful consideration must be given to the heat of the IC from the two standpoints of immediate damage and long-term reliability of operation.





Power dissipation values vary according to the board on which the IC is mounted.

I/O Equivalent Circuits

| Terminal No. | Terminal Name | Terminal Voltage | Equivalent Circuit | Terminal Description |
|--|--|---------------------|--------------------|---|
| 1 2 3 4 5 6 | A1 A2 B1 B2 C1 C2 | 4.25 | | A terminal for signal input. The input impedance is 100kΩ(Typ). |
| 7 8 9 10 11 12 | DP1 DN DP2 EP1 EN EP2 | 4.25 | | Input terminal available to ingle/Differential mode. The input impedance is 250kΩ(Typ). |
| 16 18 | SBB1 SBB2 | - | | An input terminal for Super Bass |
| 15 17 19 22 23 24 25 26 27 | SBA1 SBBIAS SBA2 OUTS2 OUTS1 OUTR2 OUTR1 OUTF2 OUTF1 | 4.25 | | A terminal for Super Bass and fader, Subwoofer output. |
| 14 20 | SBC1 SBC2 | 4.25 | | An output terminal for Super Bass. |

Values in the pin explanation and input/output equivalent circuit are reference values only and are not guaranteed.

I/O Equivalent Circuits - continued

| Terminal No. | Terminal Name | Terminal Voltage | Equivalent Circuit | Terminal Description |
|-----------------|------------------|---------------------|--|---|
| 28 | VCC | 8.5 | | Power supply terminal. |
| 29 | SCL | - | | A terminal for clock input of I ² C BUS communication. |
| 30 | SDA | - | VCC VCC VCC VCC VCC VCC VCC VCC | A terminal for data input of I ² C BUS communication. |
| 31 | GND | 0 | | Ground terminal. |
| 32 | FIL | 4.25 | | 1/2 VCC terminal. Voltage for reference bias of analog signal system. The simple precharge circuit and simple discharge circuit for an external capacitor are built in. |
| 13 | MIN | 4.25 | | A terminal for signal input. The input impedance is 27kΩ(typ). |

Values in the pin explanation and input/output equivalent circuit are reference values only and are not guaranteed.

Operational Notes

1. Reverse Connection of Power Supply

Connecting the power supply in reverse polarity can damage the IC. Take precautions against reverse polarity when connecting the power supply, such as mounting an external diode between the power supply and the IC's power supply pins.

2. Power Supply Lines

Design the PCB layout pattern to provide low impedance supply lines. Separate the ground and supply lines of the digital and analog blocks to prevent noise in the ground and supply lines of the digital block from affecting the analog block. Furthermore, connect a capacitor to ground at all power supply pins. Consider the effect of temperature and aging on the capacitance value when using electrolytic capacitors.

3. Ground Voltage

Ensure that no pins are at a voltage below that of the ground pin at any time, even during transient condition.

4. Ground Wiring Pattern

When using both small-signal and large-current ground traces, the two ground traces should be routed separately but connected to a single ground at the reference point of the application board to avoid fluctuations in the small-signal ground caused by large currents. Also ensure that the ground traces of external components do not cause variations on the ground voltage. The ground lines must be as short and thick as possible to reduce line impedance.

5. Thermal Consideration

Should by any chance the power dissipation rating be exceeded the rise in temperature of the chip may result in deterioration of the properties of the chip. In case of exceeding this absolute maximum rating, increase the board size and copper area to prevent exceeding the Pd rating.

6. Recommended Operating Conditions

These conditions represent a range within which the expected characteristics of the IC can be approximately obtained. The electrical characteristics are guaranteed under the conditions of each parameter.

7. Inrush Current

When power is first supplied to the IC, it is possible that the internal logic may be unstable and inrush current may flow instantaneously due to the internal powering sequence and delays, especially if the IC has more than one power supply. Therefore, give special consideration to power coupling capacitance, power wiring, width of ground wiring, and routing of connections.

8. Operation Under Strong Electromagnetic Field

Operating the IC in the presence of a strong electromagnetic field may cause the IC to malfunction.

9. Testing on Application Boards

When testing the IC on an application board, connecting a capacitor directly to a low-impedance output pin may subject the IC to stress. Always discharge capacitors completely after each process or step. The IC's power supply should always be turned off completely before connecting or removing it from the test setup during the inspection process. To prevent damage from static discharge, ground the IC during assembly and use similar precautions during transport and storage.

10. Inter-pin Short and Mounting Errors

Ensure that the direction and position are correct when mounting the IC on the PCB. Incorrect mounting may result in damaging the IC. Avoid nearby pins being shorted to each other especially to ground, power supply and output pin. Inter-pin shorts could be due to many reasons such as metal particles, water droplets (in very humid environment) and unintentional solder bridge deposited in between pins during assembly to name a few.

11. Unused Input Pins

Input pins of an IC are often connected to the gate of a MOS transistor. The gate has extremely high impedance and extremely low capacitance. If left unconnected, the electric field from the outside can easily charge it. The small charge acquired in this way is enough to produce a significant effect on the conduction through the transistor and cause unexpected operation of the IC. So unless otherwise specified, unused input pins should be connected to the power supply or ground line.

Operational Notes – continued

12. Regarding the Input Pin of the IC

This monolithic IC contains P+ isolation and P substrate layers between adjacent elements in order to keep them isolated. P-N junctions are formed at the intersection of the P layers with the N layers of other elements, creating a parasitic diode or transistor. For example (refer to figure below):

When GND > Pin A and GND > Pin B, the P-N junction operates as a parasitic diode. When GND > Pin B, the P-N junction operates as a parasitic transistor.

Parasitic diodes inevitably occur in the structure of the IC. The operation of parasitic diodes can result in mutual interference among circuits, operational faults, or physical damage. Therefore, conditions that cause these diodes to operate, such as applying a voltage lower than the GND voltage to an input pin (and thus to the P substrate) should be avoided.

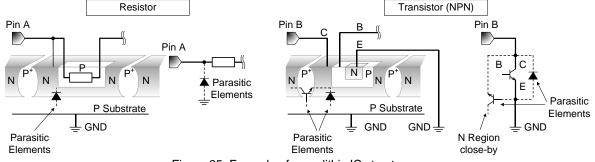
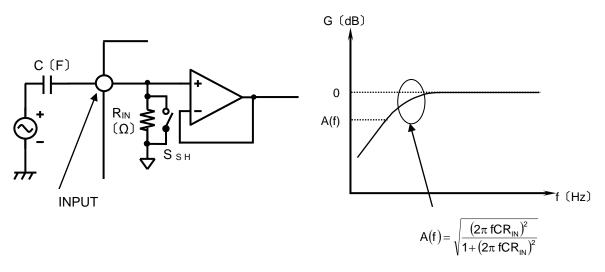


Figure 25. Example of monolithic IC structure

13. About Signal Input

(a) About Input Coupling Capacitor Constant Value

The constant value of input coupling capacitor C(F) is decided with respect to the input impedance $R_{IN}(\Omega)$ at the input signal terminal of the IC. The first HPF characteristic of RC is composed.



(b) About the Input Selector SHORT

SHORT mode is the command which makes switch S_{SH} =ON of input selector part so that the input impedance R_{IN} of all terminals becomes small. Switch S_{SH} is OFF when SHORT command is not selected. The constant time brought about by the small resistance inside and the capacitor outside the LSI becomes small when this command is used. The charge time of the capacitor becomes short. Since SHORT mode turns ON the switch of S_{SH} and makes it low impedance, please use it at no signal condition.

Operational Notes – continued

- 14. About MIX
 - (1) <u>About Specification of Fader -∞ at MIX ON.</u> Mix_signal is added to Main_signal after Fader_Gain(+15dB to -79dB) like the figure. When Fader is set at -∞, the signal after a MIX signal is added is done with MUTE because the -∞ circuit of Fader is in the step after the addition circuit

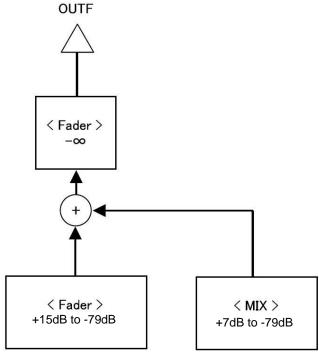
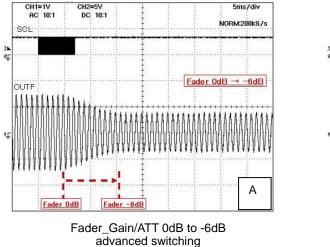
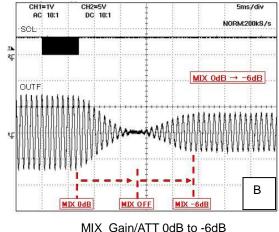


Figure 26. About Front Fader and MIX

(2) <u>About Advanced Switching of MIX_Gain/ATT</u> When advanced switching of MIX_Gain/ATT works, MIX goes a switching movement that it passes through the state of MIX_OFF like in B figure below (from current settingof MIX_Gain/ATT to MIX_OFF to a target setting of MIX_Gain/ATT).





MIX_Gain/ATT 0dB to -6dB advanced switching

Figure 27. Advanced Switching Movement when MIX_Gain/ATT is Changed

Operational Notes – continued

15. About Super Bass Circuit

The (the following Super Bass) which strengthens a low band like the graph below a can be realized by composing an external circuit with the pin 14 to 20 as shown in Figure 28.

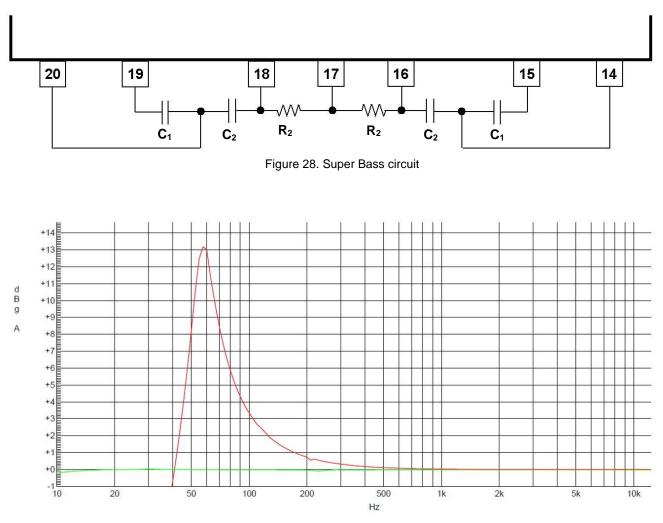
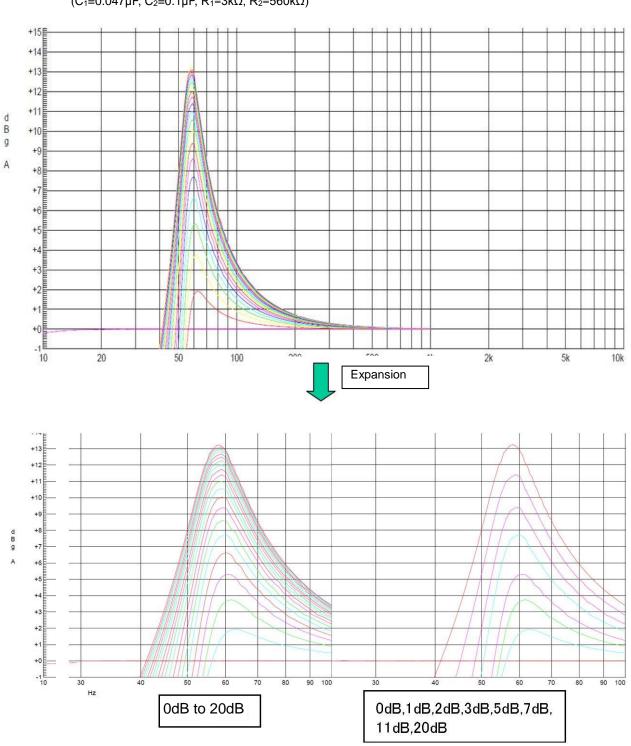


Figure 29. Super Bass Gain vs Frequency

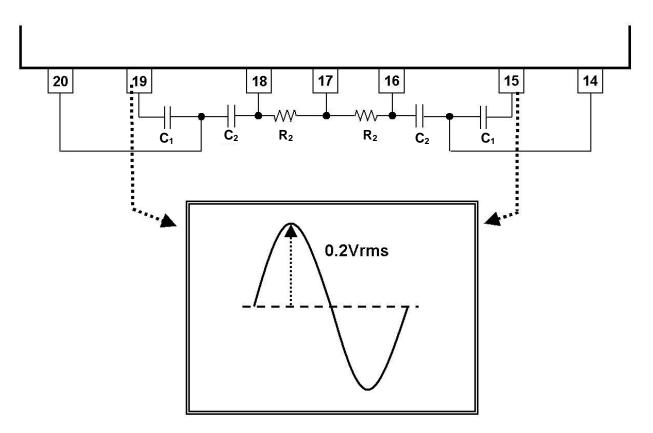


(a) <u>Gain Step Width becomes a Logarithm</u> When a setup of Gain is made 0,1,2,3,5,7,11,20dB, it becomes the following (bottom right) character. $(C_1=0.047\mu$ F, $C_2=0.1\mu$ F, $R_1=3k\Omega$, $R_2=560k\Omega$)

Figure 30. About Gain step of Super Bass

(b) You must take level diagram into consideration so that output may not do a clip

<u>Example (C₁=0.047µF, C₂=0.1µF, R₂=560kohm, V_{CC}=8.5V)</u> To prevent output clipping due to amplification when Super Bass is used, adjust the level diagram with volume until the Tone output level becomes less than 0.2Vrms.



Please adjust so that the maximum level of the Tone output becomes less than 0.2Vrms. (at Vcc=8.5V)

Figure 31. Super Bass Level Diagram

(c) About fo and Gain of Super Bass

fo and Gain of Super Bass deviates due to the deviation of the value of C_1 , C_2 , R_2 (Components with the outside), P_2 (the resistance built in |C|)

 R_1 (the resistance built in IC).

<u>Example</u> : Super Bass Gain – frequency characteristic at Dispersion condition of C_{1} , C_{2} , R_{2} ±5%, R_{1} ±30% (C_{1} =0.047 μ F, C_{2} =0.1 μ F, R_{1} =3kohm, R_{2} =560kohm, Super Bass Gain=20dB)

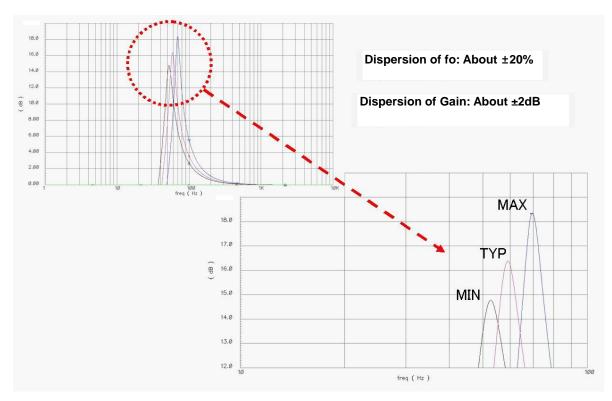
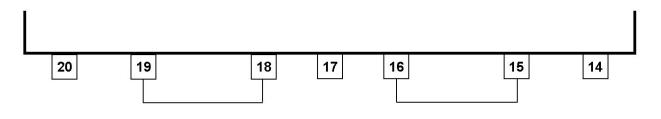


Figure 32. Dispersion of fo and Gain of Super Bass

(d) How to Deal with Pins of Super Bass when not used

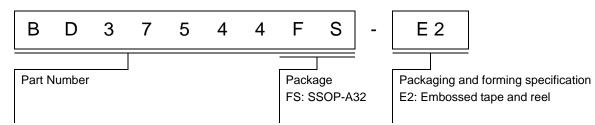
Short Pins 15 to 16, Pins 18 to 19 as shown in Figure 33 when the Super Bass function is not used.



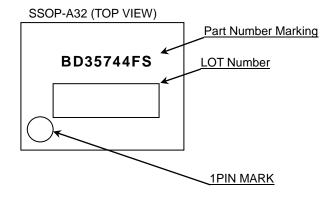
Short Pin 15 to 16, Pin 18 to 19

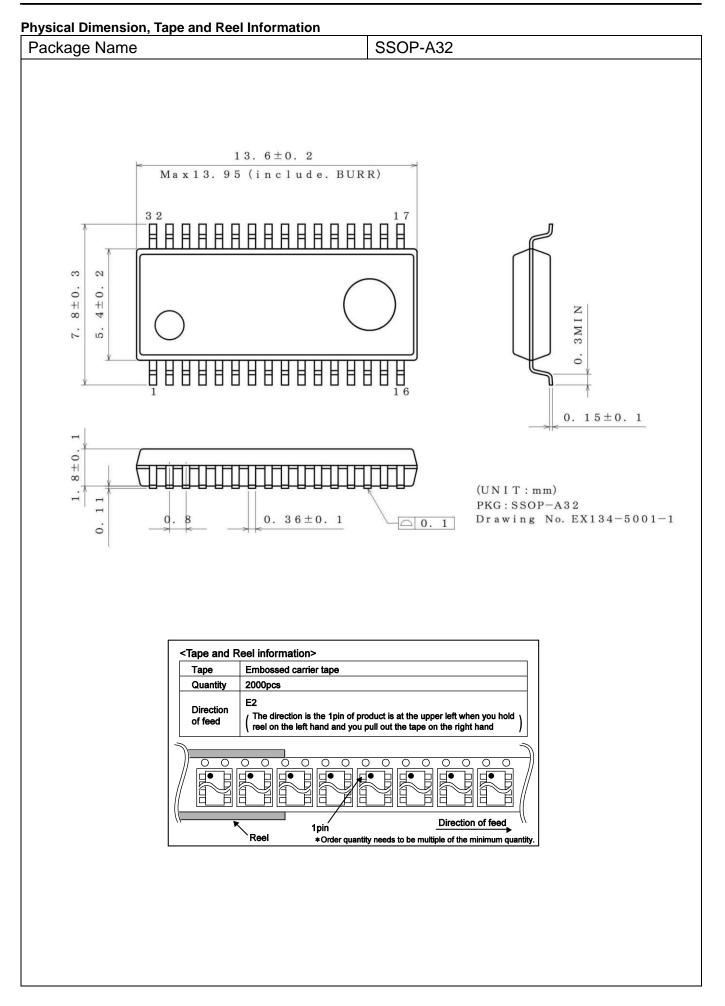
Figure 33. How to Deal with Pins of Super Bass when not used

Ordering Information



Marking Diagram





Revision History

| Date | Revision | Changes |
|-------------|----------|-------------|
| 16.Dec.2015 | 001 | New Release |

Notice

Precaution on using ROHM Products

1. Our Products are designed and manufactured for application in ordinary electronic equipments (such as AV equipment, OA equipment, telecommunication equipment, home electronic appliances, amusement equipment, etc.). If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment ^(Note 1), transport equipment, traffic equipment, aircraft/spacecraft, nuclear power controllers, fuel controllers, car equipment including car accessories, safety devices, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

| (Note1) Medical Equipment Classification of the Specific Applications |
|---|
|---|

| JAPAN | USA | EU | CHINA |
|--------|--------|------------|--------|
| CLASSⅢ | CLASSⅢ | CLASS II b | CLASSI |
| CLASSⅣ | | CLASSⅢ | |

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 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
- 2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

Precaution for Product Label

QR code printed on ROHM Products label is for ROHM's internal use only.

Precaution for Disposition

When disposing Products please dispose them properly using an authorized industry waste company.

Precaution for Foreign Exchange and Foreign Trade act

Since concerned goods might be fallen under listed items of export control prescribed by Foreign exchange and Foreign trade act, please consult with ROHM in case of export.

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Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

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